

SGM72004A High Linearity SP4T RF Switch

GENERAL DESCRIPTION

The SGM72004A is a single-pole/four-throw (SP4T) antenna switch, which supports from 0.1GHz to 3GHz. The device features low insertion loss and high isolation, which makes it suitable for high linearity receiving application. It also has the advantage of high linearity performance. The SGM72004A is not subject to cellular interference and is applied to multi-mode and multi-band LTE mobile phones.

The SGM72004A has the ability to integrate SP4T RF switch and GPIO controller on an SOI chip. Internal driver and decoder for switch control signals are offered by the GPIO controller, which makes it flexible in RF path band and routing selection.

No external DC blocking capacitors required on the RF paths as long as no external DC voltage is applied, which can save PCB area and cost.

The SGM72004A is available in a Green ULGA-1.1×1.1-9L package.

APPLICATIONS

2G/3G/4G Receiving

FEATURES

- Supply Voltage Range: 2.4V to 3V
- GPIO Controller
- Operating Frequency Range: 0.1GHz to 3GHz
- Advanced Silicon-On-Insulator (SOI) Process
- Low Insertion Loss: 0.4dB (TYP) at 2.7GHz
- High Isolation: 18dB (MIN) at 2.7GHz
- No External DC Blocking Capacitors Required
- Available in a Green ULGA-1.1×1.1-9L Package

BLOCK DIAGRAM

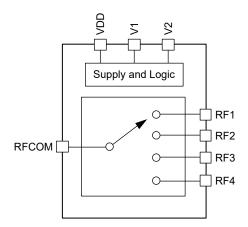


Figure 1. SGM72004A Block Diagram



PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	TEMPERATURE ORDERING		PACKING OPTION	
SGM72004A	ULGA-1.1×1.1-9L	-40°C to +85°C	SGM72004AYULA9G/TR	PD	Tape and Reel, 3000	

MARKING INFORMATION

NOTE: Fixed character for PD.



YΥ

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

3.3V
3V
27dBm
+150°C
55°C to +150°C
+260°C
1000V

RECOMMENDED OPERATING CONDITIONS

Operating Temperature Range	40°C to +85°C
Operating Frequency Range	0.1GHz to 3GHz
Supply Voltage, V _{DD}	2.4V to 3V
Control High Voltage, V _{CTL_H}	1.35V to 3V
Control Low Voltage, V _{CTL_L}	0V to 0.4V

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

ESD SENSITIVITY CAUTION

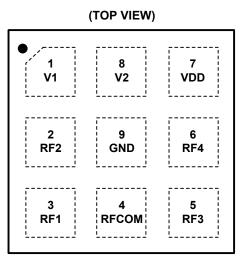
This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.



PIN CONFIGURATION



ULGA-1.1×1.1-9L

PIN DESCRIPTION

PIN	NAME	FUNCTION
1	V1	DC Control Voltage 1.
2	RF2	RF Port 2.
3	RF1	RF Port 1.
4	RFCOM	RF Common Port.
5	RF3	RF Port 3.
6	RF4	RF Port 4.
7	VDD	DC Power Supply.
8	V2	DC Control Voltage 2.
9	GND	Ground.

LOGIC TRUTH TABLE

VDD	V1	V2	ACTIVE PATH
н	L	н	RFCOM to RF1
Н	н	L	RFCOM to RF2
Н	н	н	RFCOM to RF3
н	L	L	RFCOM to RF4



ELECTRICAL CHARACTERISTICS

(V_{DD} = 2.4V to 3V, T_A = +25°C, P_{IN} = 0dBm, 50Ω, typical values are at V_{DD} = 2.8V, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DC Specifications		•				
Supply Voltage	V _{DD}		2.4	2.8	3	V
Supply Current	I _{DD}			32	65	μA
Control Voltago	V _{CTL_H}	High	1.35	1.8	3	v
Control Voltage	V _{CTL_L}	Low	0		0.4	v
Control Current	ICTL	V _{CTL} = 0V		3	7	μA
Switching Time	t _{sw}	50% of control voltage to 90% of RF power		1	2	μs
Turn-On Time	t _{on}	Fime from $V_{DD} = 0V$ to part on and RF at 90%		5	10	μs
RF Specifications						
		0.1GHz to 1.0GHz		0.20	0.41	
Insertion Loss (RFCOM to All RF Ports)	IL 1	1.0GHz to 2.0GHz		0.30	0.65	dB
		2.0GHz to 2.7GHz		0.40	1.01	
		0.1GHz to 1.0GHz	29	35		
Isolation (RFCOM to All RF Ports)	ISO	1.0GHz to 2.0GHz	19	30		dB
(2.0GHz to 2.7GHz	18	25		
		0.1GHz to 1.0GHz		25		
Input Return Loss (RFCOM to All RF Ports)	RL	1.0GHz to 2.0GHz		24		dB
		2.0GHz to 2.7GHz		23		1
0.1dB Compression Point (RFCOM to All RF Ports) P _{0.1dB} 0.1GHz to 3GHz		0.1GHz to 3GHz		27		dBm

TYPICAL APPLICATION CIRCUIT

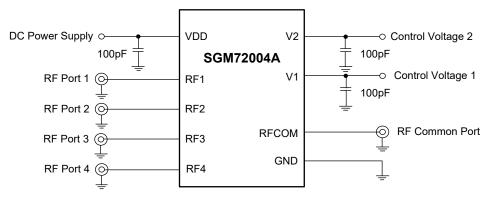


Figure 2. SGM72004A Typical Application Circuit

EVALUATION BOARD LAYOUT

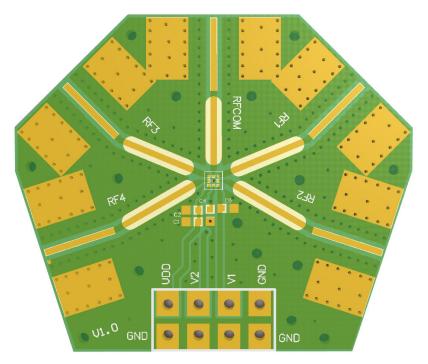


Figure 3. SGM72004A Evaluation Board Layout

REVISION HISTORY

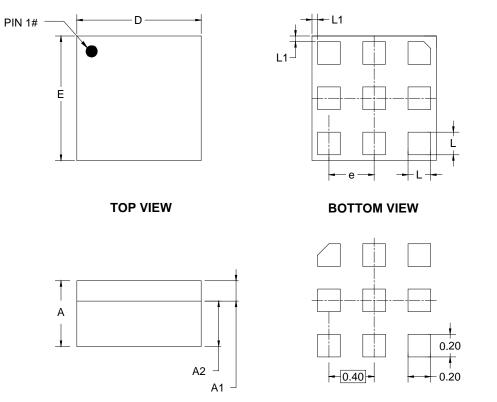
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Original (MARCH 2022) to REV.A	Page
Changed from product preview to production data	All
SG Micro Corn	MARCH 2022

SG Micro Corp

PACKAGE OUTLINE DIMENSIONS

ULGA-1.1×1.1-9L



SIDE VIEW

RECOMMENDED LAND PATTERN (Unit: mm)

Symbol	Dimensions In Millimeters					
Symbol	MIN	MOD	МАХ			
А	0.530	0.530 0.580				
A1	0.150	0.210				
A2	0.400 BSC					
D	1.000 1.100		1.200			
E	1.000 1.100		1.200			
е	0.400 BSC					
L	0.150 0.200 0.2		0.250			
L1	0.050 REF					

NOTE: This drawing is subject to change without notice.



TAPE AND REEL INFORMATION

REEL DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
ULGA-1.1×1.1-9L	7″	8.6	1.26	1.26	0.72	4.0	4.0	2.0	8.0	Q2

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton	
7" (Option)	368	227	224	8	
7"	442	410	224	18	DD0002

